

## 1. General description

Dual common cathode power Schottky diode in TO220 plastic package.



## 2. Features and benefits

- High junction temperature up to 175 °C
- Low forward voltage drop, negligible switching losses
- High efficiency

## 3. Applications

- DC to DC converters
- Freewheeling diode
- OR-ing diode
- Switched mode power supply rectifier

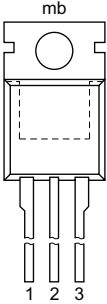
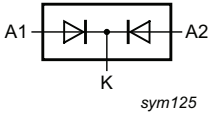
## 4. Quick reference data

Table 1. Quick reference data

Table 1: Quick reference data							
Symbol	Parameter	Conditions	Notes	Values			Unit
Absolute maximum rating							
V <sub>RRM</sub>	repetitive peak reverse voltage			200			V
I <sub>F(AV)</sub>	average forward current	δ = 0.5; square-wave pulse; T <sub>mb</sub> ≤ 154 °C; per diode; <a href="#">Fig. 1</a> ; <a href="#">Fig. 2</a> ; <a href="#">Fig. 3</a>		10			A
I <sub>O(AV)</sub>	average output current	δ = 0.5; square-wave pulse; T <sub>mb</sub> ≤ 152 °C; both diodes conducting		20			A
Symbol	Parameter	Conditions	Notes	Min	Typ	Max	Unit
Static characteristics							
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 10 A; T <sub>j</sub> = 25 °C; per diode; <a href="#">Fig. 6</a>		-	0.86	0.93	V
I <sub>R</sub>	reverse current	V <sub>R</sub> = 200 V; T <sub>j</sub> = 25 °C; per diode; <a href="#">Fig. 7</a>		-	0.03	5	μA

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	A1	anode 1		
2	K	cathode		
3	A2	anode 2		
mb	K	mounting base; connected to cathode		

6. Ordering information

Table 3. Ordering information

Type number	Package name	Orderable part number	Packing method	Small packing quantity	Package version	Package issue date
WN3S20200CT	TO220	WN3S20200CTQ	Tube	50	SOT78	13-Jun-2008

7. Marking

Table 4. Marking codes

Type number	Marking codes
WN3S20200CT	WN3S20 200CT

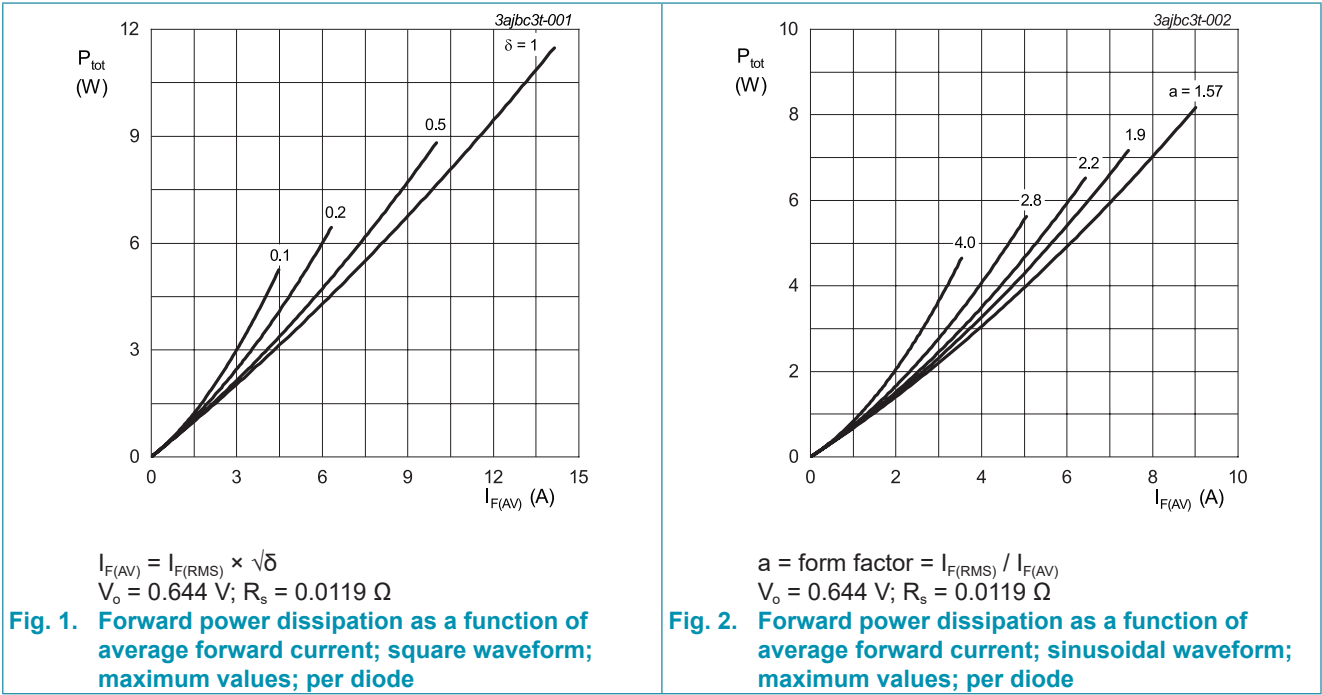
8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Notes	Values	Unit
$V_{RRM}$	repetitive peak reverse voltage			200	V
$V_{RWM}$	crest working reverse voltage			200	V
$V_R$	reverse voltage	DC		200	V
$I_{F(AV)}$	average forward current	$\delta = 0.5$ ; square-wave pulse; $T_{mb} \leq 154\text{ }^{\circ}\text{C}$ ; per diode; Fig. 1; Fig. 2; Fig. 3		10	A
$I_{O(AV)}$	average output current	$\delta = 0.5$ ; square-wave pulse; $T_{mb} \leq 152\text{ }^{\circ}\text{C}$ ; both diodes conducting		20	A
$I_{FSM}$	non-repetitive peak forward current	$t_p = 10\text{ ms}$ ; $T_{j(\text{init})} = 25\text{ }^{\circ}\text{C}$ ; sine-wave pulse; per diode; Fig. 4		150	A
		$t_p = 8.3\text{ ms}$ ; $T_{j(\text{init})} = 25\text{ }^{\circ}\text{C}$ ; sine-wave pulse; per diode		165	A
$T_{stg}$	storage temperature			-40 to 175	$^{\circ}\text{C}$
$T_j$	junction temperature		[1]	-40 to 175	$^{\circ}\text{C}$

[1] The heat generated must be less than the thermal conductivity from Junction to Ambient:  $dP_{tot}/dT_j < 1/R_{th(j-a)}$



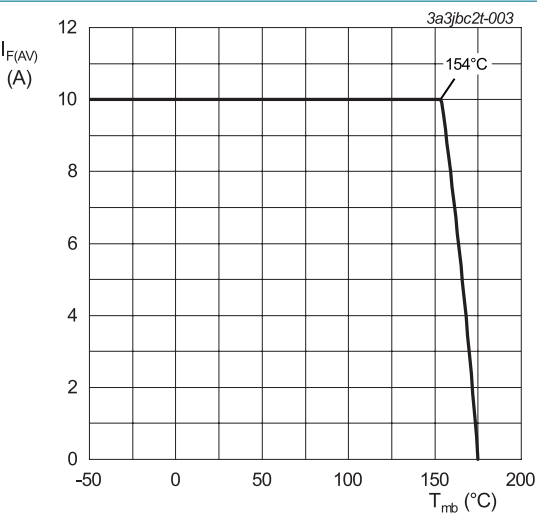


Fig. 3. Average forward current as a function of mounting base temperature; maximum values; per diode

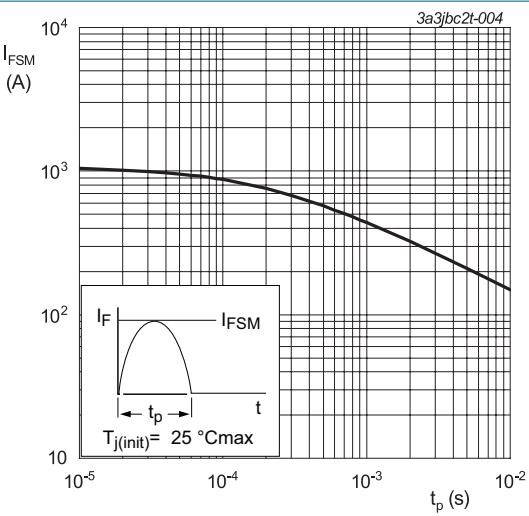


Fig. 4. Non-repetitive peak forward current as a function of pulse width; sinusoidal waveform; maximum values; per diode

9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions	Notes	Min	Typ	Max	Unit
$R_{th(j-mb)}$	thermal resistance from junction to mounting base	per diode; Fig. 5		-	-	2.4	K/W
		both diodes conducting		-	-	1.3	K/W
$R_{th(j-a)}$	thermal resistance from junction to ambient free air	in free air		-	60	-	K/W

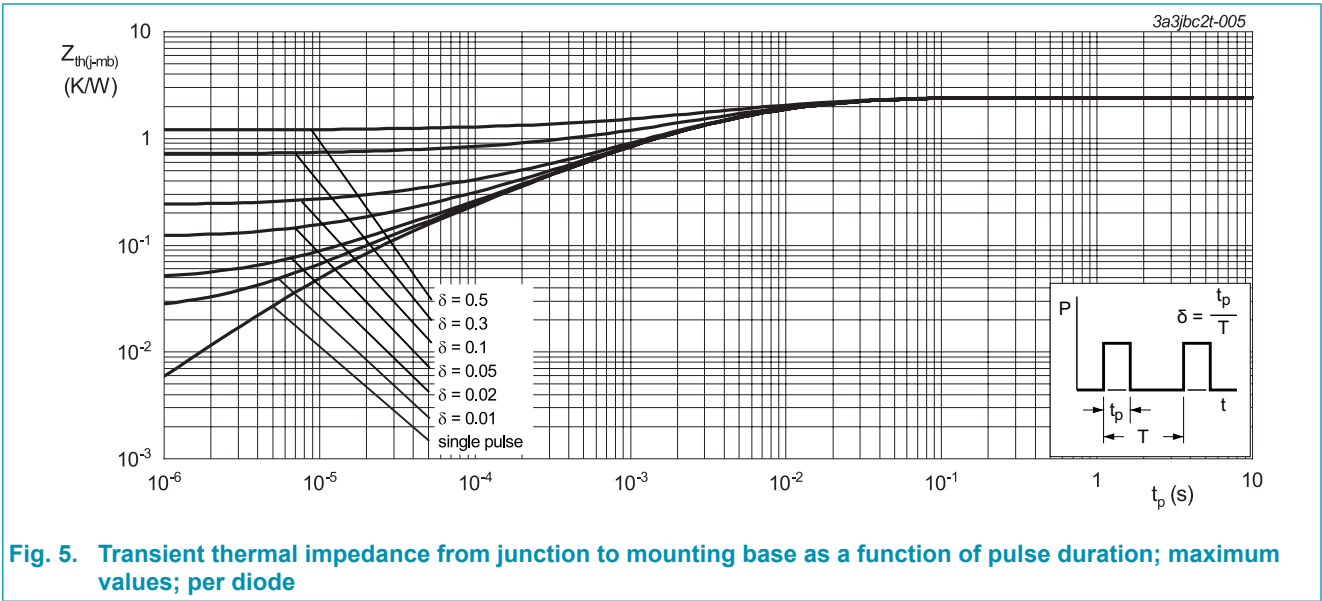
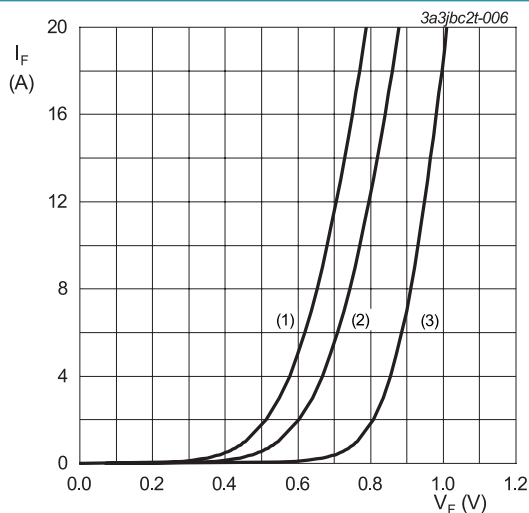


Fig. 5. Transient thermal impedance from junction to mounting base as a function of pulse duration; maximum values; per diode

10. Characteristics

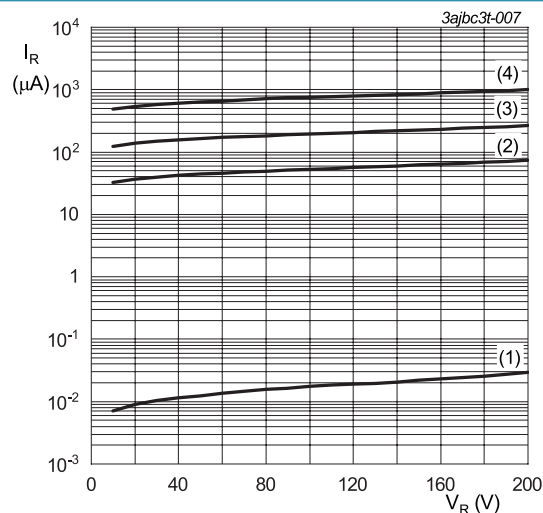
Table 7. Characteristics

Symbol	Parameter	Conditions	Notes	Min	Typ	Max	Unit
Static characteristics							
$V_F$	forward voltage	$I_F = 10\text{ A}$ ; $T_j = 25\text{ °C}$ ; per diode; <a href="#">Fig. 6</a>		-	0.86	0.93	V
		$I_F = 10\text{ A}$ ; $T_j = 125\text{ °C}$ ; per diode		-	0.75	-	V
		$I_F = 10\text{ A}$ ; $T_j = 175\text{ °C}$ ; per diode; <a href="#">Fig. 6</a>		-	0.70	0.77	V
$I_R$	reverse current	$V_R = 200\text{ V}$ ; $T_j = 25\text{ °C}$ ; per diode; <a href="#">Fig. 7</a>		-	0.03	5	$\mu\text{A}$
		$V_R = 200\text{ V}$ ; $T_j = 125\text{ °C}$ ; per diode; <a href="#">Fig. 7</a>		-	0.1	-	mA



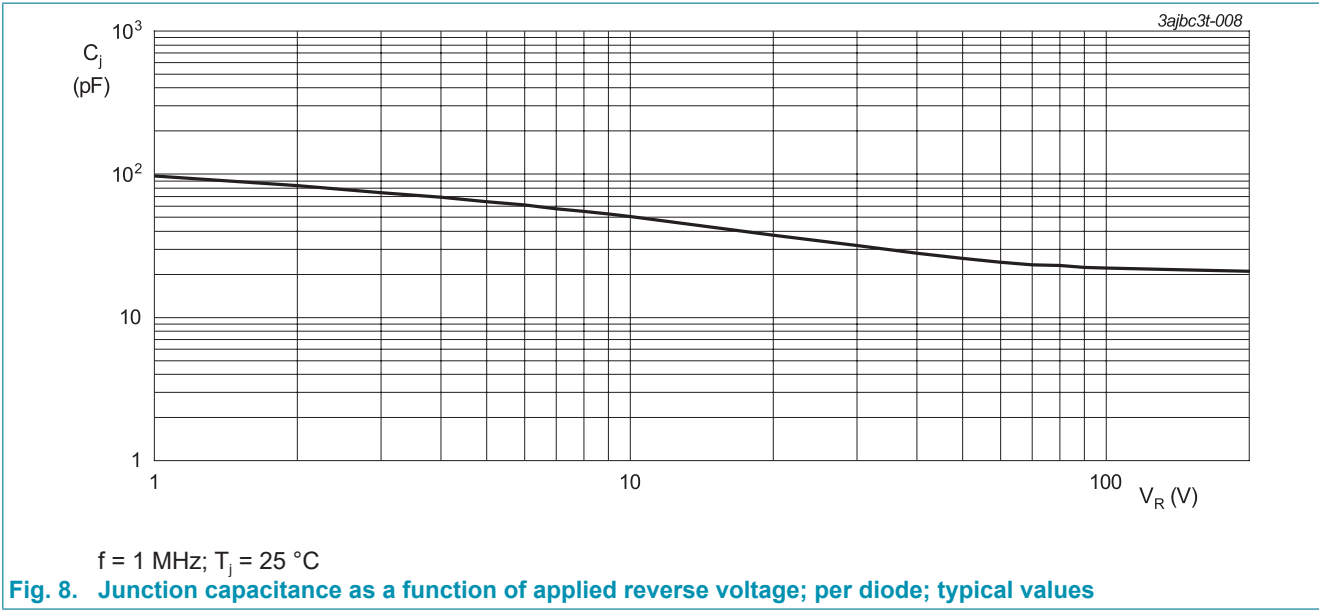
$V_o = 0.644\text{ V}$ ;  $R_s = 0.0119\text{ }\Omega$   
(1)  $T_j = 175\text{ °C}$ ; typical values  
(2)  $T_j = 175\text{ °C}$ ; maximum values  
(3)  $T_j = 25\text{ °C}$ ; maximum values

Fig. 6. Forward current as a function of forward voltage; per diode



(1)  $T_j = 25\text{ °C}$ ; typical values  
(2)  $T_j = 125\text{ °C}$ ; typical values  
(3)  $T_j = 150\text{ °C}$ ; typical values  
(4)  $T_j = 175\text{ °C}$ ; typical values

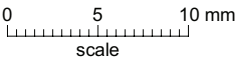
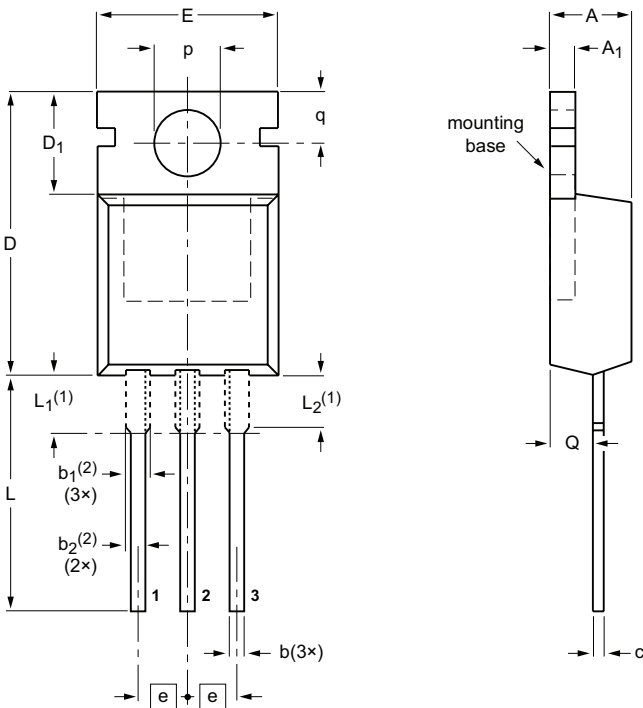
Fig. 7. Reverse leakage current as a function of reverse voltage; per diode; typical values



11. Package outline

Plastic single-ended package; heatsink mounted; 1 mounting hole; 3-lead TO-220AB

SOT78



DIMENSIONS (mm are the original dimensions)

UNIT	A	A <sub>1</sub>	b	b <sub>1</sub> <sup>(2)</sup>	b <sub>2</sub> <sup>(2)</sup>	c	D	D <sub>1</sub>	E	e	L	L <sub>1</sub> <sup>(1)</sup>	L <sub>2</sub> <sup>(1)</sup> max.	p	q	Q
mm	4.7 4.1	1.40 1.25	0.9 0.6	1.6 1.0	1.3 1.0	0.7 0.4	16.0 15.2	6.6 5.9	10.3 9.7	2.54	15.0 12.8	3.30 2.79	3.0	3.8 3.5	3.0 2.7	2.6 2.2

- Notes
- 1. Lead shoulder designs may vary.
  - 2. Dimension includes excess dambar.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA			
SOT78		3-lead TO-220AB	SC-46			08-04-23 08-06-13



## 12. Legal information

### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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Product [short] data sheet	Production	This document contains the product specification.

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